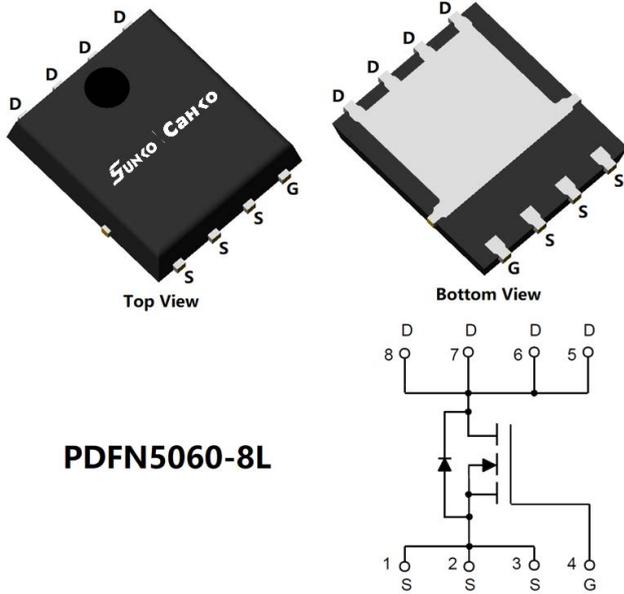


P-Channel Enhancement Mode Field Effect Transistor



PDFN5060-8L

Product Summary

- V_{DS} -100 V
- I_D -25 A
- $R_{DS(ON)}$ (at $V_{GS}=-10V$) <55 m Ω
- $R_{DS(ON)}$ (at $V_{GS}=-4.5V$) <64 m Ω
- 100% EAS Tested
- 100% ∇V_{DS} Tested

General Description

- Trench Power MOSFET technology
- Low $R_{DS(on)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity
- High density cell design for low $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Power management
- Portable equipment

■ Absolute Maximum Ratings ($T_J=25^\circ C$ unless otherwise noted)

| Parameter | | Symbol | Limit | Unit | |
|--|--------------------------------|--|----------|------------|----|
| Drain-source Voltage | | V_{DS} | -100 | V | |
| Gate-source Voltage | | V_{GS} | ± 20 | V | |
| Continuous Drain Current (Note 1,2) | Steady-State | $T_A=25^\circ C$ | -4 | A | |
| | | $T_A=100^\circ C$ | -2.5 | | |
| Continuous Drain Current (Note 1,3) | Steady-State | $T_C=25^\circ C$ | -25 | | |
| | | $T_C=100^\circ C$ | -15.5 | | |
| Pulsed Drain Current | $T_C=25^\circ C, t_p=100\mu s$ | I_{DM} | -100 | A | |
| Avalanche energy | | $V_G=-10V, R_G=25\Omega, L=2mH, I_{AS}=-12A$ | EAS | 144 | mJ |
| Total Power Dissipation (Note 1,2) | Steady-State | $T_A=25^\circ C$ | 2.2 | W | |
| | | $T_A=100^\circ C$ | 0.9 | | |
| Total Power Dissipation (Note 1,3) | Steady-State | $T_C=25^\circ C$ | 62.5 | | |
| | | $T_C=100^\circ C$ | 25 | | |
| Junction and Storage Temperature Range | | T_J, T_{STG} | -55~+150 | $^\circ C$ | |

■ Thermal resistance

| Parameter | | Symbol | Typ | Max | Units |
|---|--------------|-----------------|-----|-----|--------------|
| Thermal Resistance Junction-to-Ambient (Note 2) | Steady-State | $R_{\theta JA}$ | 45 | 55 | $^\circ C/W$ |
| Thermal Resistance Junction-to-Case | Steady-State | $R_{\theta JC}$ | 1.7 | 2 | |

■ Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | Marking | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|------------|----------------------|-------------------------|----------------------------|---------------|
| SCG055P10A | F1 | SCG055P10A | 5000 | 10000 | 100000 | 13" reel |

SCG055P10A

■ Electrical Characteristics (T_J=25°C unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
|---------------------------------------|---------------------|--|------|------|------|-------|
| Static Parameter | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} = 0V, I _D =-250μA | -100 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =-100V, V _{GS} =0V | - | - | -1 | μA |
| | | V _{DS} =-100V, V _{GS} =0V, T _J =150°C | - | - | -100 | |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} = ±20V, V _{DS} =0V | - | - | ±100 | nA |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D =-250μA | -1.5 | -2.0 | -2.5 | V |
| Static Drain-Source On-Resistance | R _{DS(on)} | V _{GS} =-10V, I _D =-20A | - | 42 | 55 | mΩ |
| | | V _{GS} =-4.5V, I _D =-15A | - | 47 | 64 | |
| Diode Forward Voltage | V _{SD} | I _S =-20A, V _{GS} =0V | - | - | -1.2 | V |
| Gate resistance | R _G | f=1MHz | - | 6 | - | Ω |
| Maximum Body-Diode Continuous Current | I _S | | - | - | -25 | A |
| Dynamic Parameters | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =-50V, V _{GS} =0V, f=1MHz | - | 3620 | - | pF |
| Output Capacitance | C _{oss} | | - | 145 | - | |
| Reverse Transfer Capacitance | C _{rss} | | - | 120 | - | |
| Switching Parameters | | | | | | |
| Total Gate Charge | Q _g | V _{GS} =-10V, V _{DS} =-50V, I _D =-20A | - | 71 | - | nC |
| Gate-Source Charge | Q _{gs} | | - | 10.8 | - | |
| Gate-Drain Charge | Q _{gd} | | - | 16.8 | - | |
| Reverse Recovery Charge | Q _{rr} | I _F =-20A, di/dt=100A/us | - | 47 | - | nC |
| Reverse Recovery Time | t _{rr} | | - | 32 | - | ns |
| Turn-on Delay Time | t _{D(on)} | V _{GS} =-10V, V _{DD} =-50V, I _D =-20A R _{GEN} =3Ω | - | 13 | - | ns |
| Turn-on Rise Time | t _r | | - | 24 | - | |
| Turn-off Delay Time | t _{D(off)} | | - | 120 | - | |
| Turn-off fall Time | t _f | | - | 61 | - | |

Note:

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- The value of R_{θJA} is measured with the device mounted on the 40mm*40mm*1.1mm single layer FR-4 PCB board with 1 in² pad of 2oz. Copper, in the still air environment with T_A =25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
- Thermal resistance from junction to soldering point (on the exposed drain pad).

Typical Electrical and Thermal Characteristics Diagrams

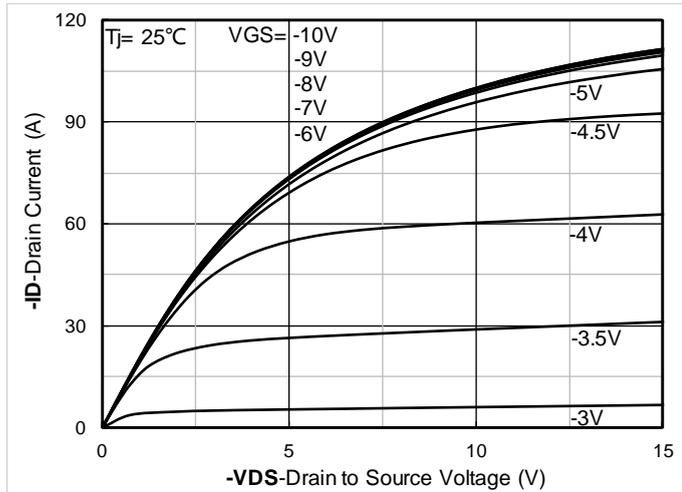


Figure 1. Output Characteristics

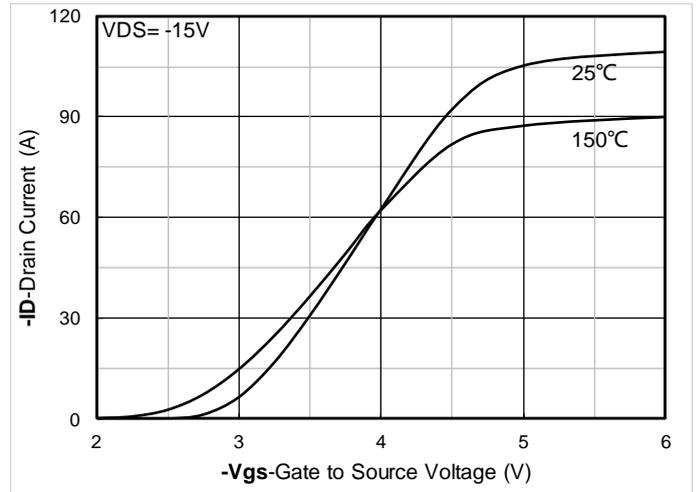


Figure 2. Transfer Characteristics

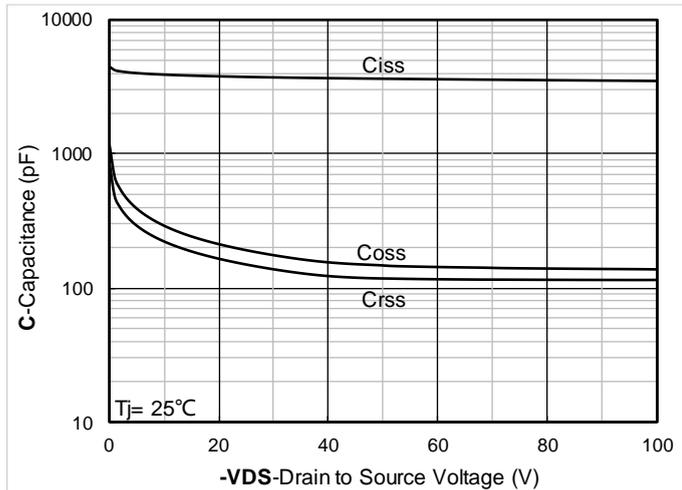


Figure 3. Capacitance Characteristics

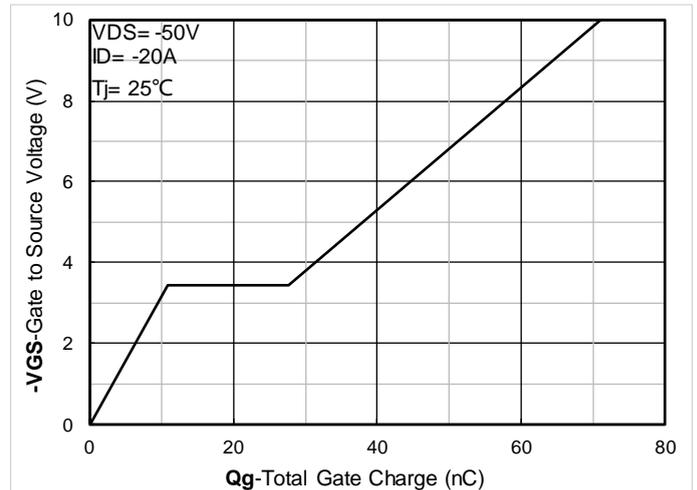


Figure 4. Gate Charge

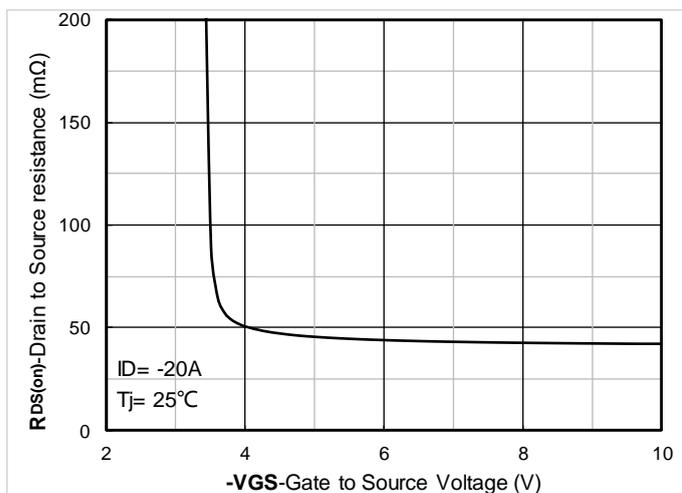


Figure 5. On-Resistance vs Gate to Source Voltage

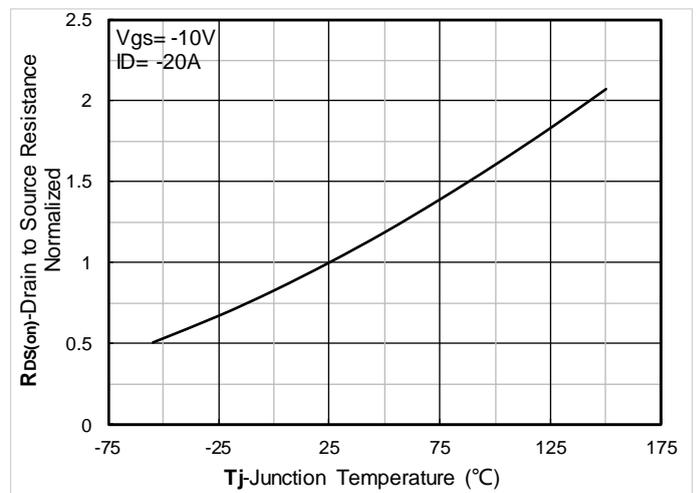


Figure 6. Normalized On-Resistance

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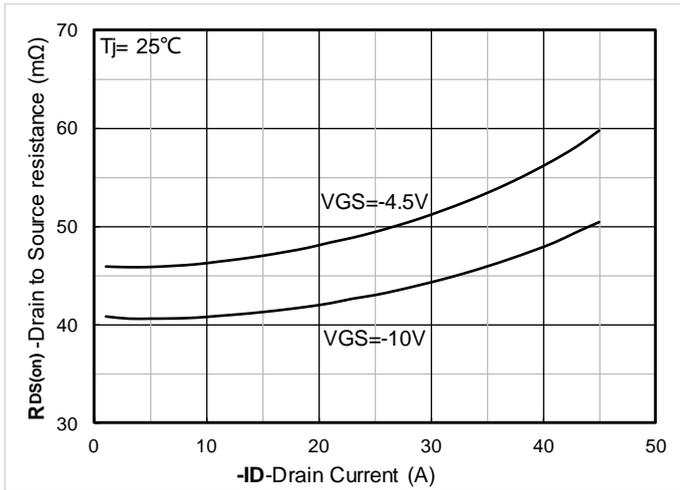


Figure 7. $R_{DS(on)}$ VS Drain Current

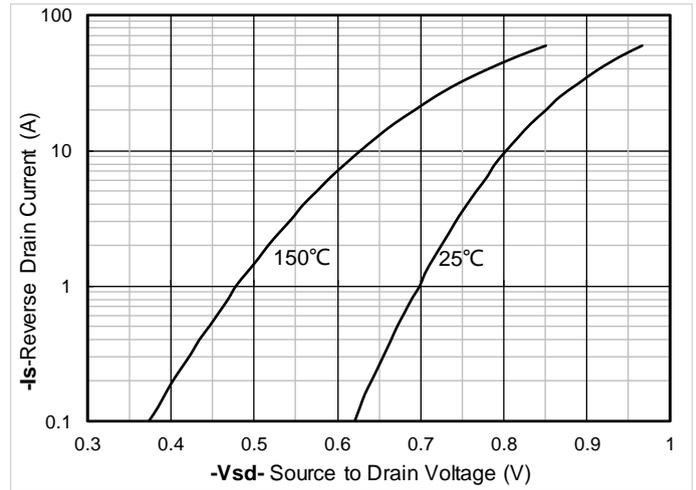


Figure 8. Forward characteristics of reverse diode

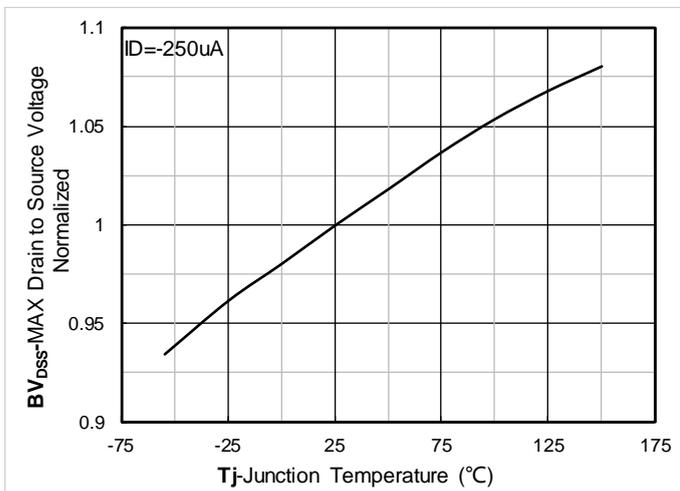


Figure 9. Normalized breakdown voltage

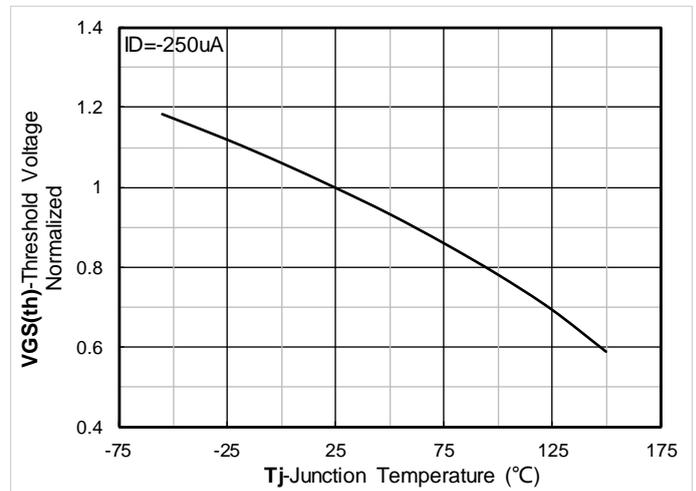


Figure 10. Normalized Threshold voltage

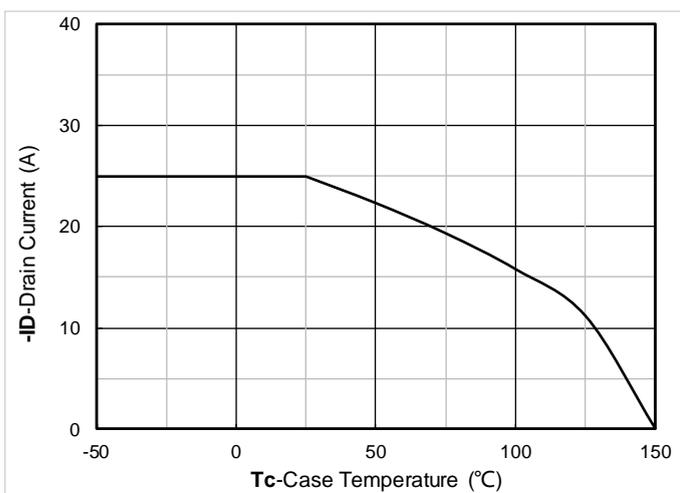


Figure 11. Current dissipation

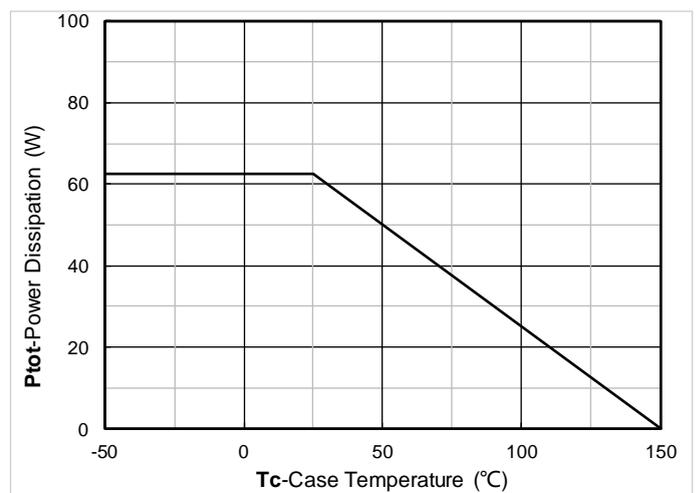


Figure 12. Power dissipation

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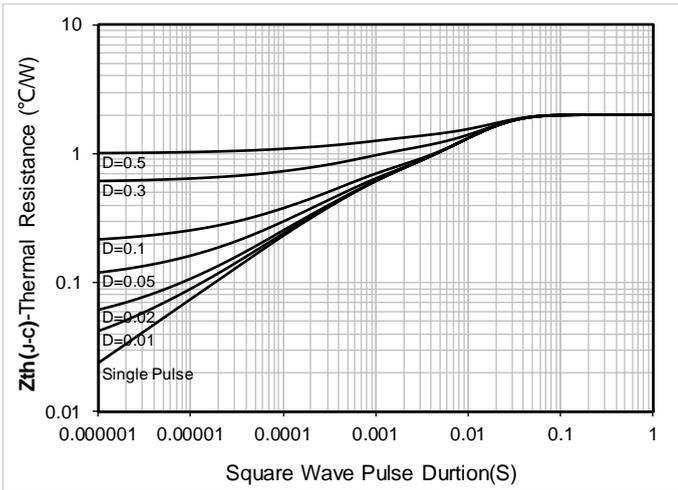


Figure 13. Maximum Transient Thermal Impedance

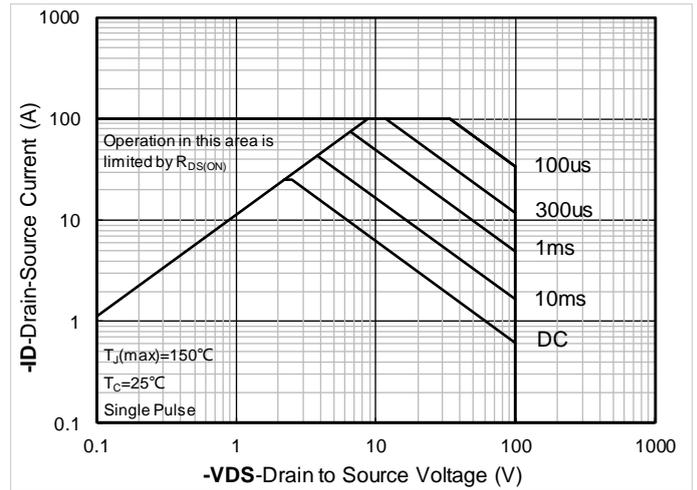
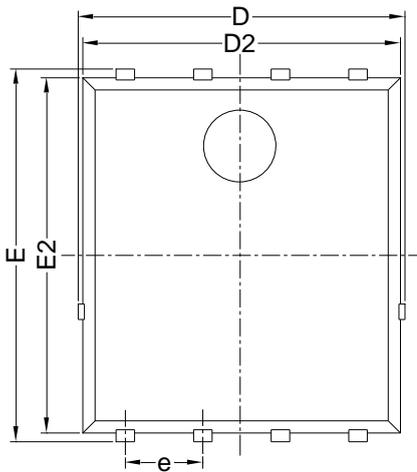


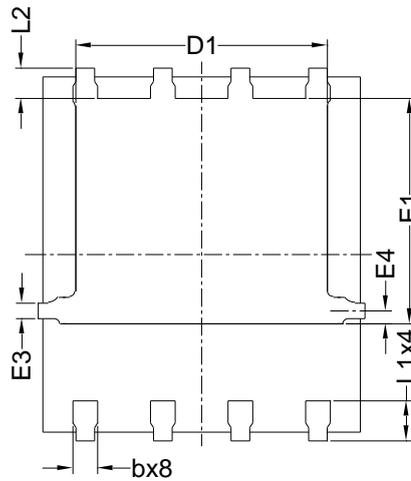
Figure 14. Safe Operation Area

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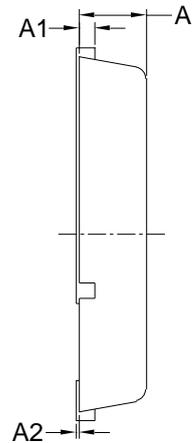
■ PDFN5060-8L-B-1.1MM Package information



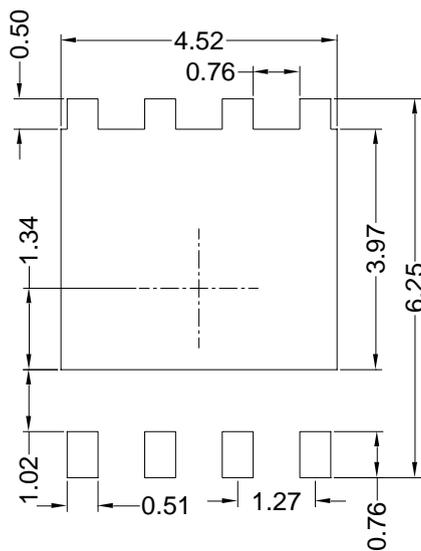
Top View
正面视图



Bottom View
背面视图



Side View
侧面视图



Suggested Solder Pad Layout
Top View

| SYMBOL | MILLIMETER | | |
|--------|------------|------|------|
| | MIN | NOM | MAX |
| D | 5.15 | 5.35 | 5.55 |
| E | 5.95 | 6.15 | 6.35 |
| A | 1.00 | 1.10 | 1.20 |
| A1 | 0.254 BSC | | |
| A2 | | | 0.10 |
| D1 | 3.92 | 4.12 | 4.32 |
| E1 | 3.52 | 3.72 | 3.92 |
| D2 | 5.00 | 5.20 | 5.40 |
| E2 | 5.66 | 5.86 | 6.06 |
| E3 | 0.254 REF | | |
| E4 | 0.21 REF | | |
| L1 | 0.56 | 0.66 | 0.76 |
| L2 | 0.50 BSC | | |
| b | 0.31 | 0.41 | 0.51 |
| e | 1.27 BSC | | |

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.10 mm.
3. The pad layout is for reference purposes only.

Disclaimer

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